- *EPIC* ™ (Enhanced-Performance Implanted CMOS) Process
- 2-V to 5.5-V V_{CC} Operation
- Support Mixed-Mode Voltage Operation on All Ports
- Designed Specifically for High-Speed Memory Decoders and Data-Transmission Systems
- Incorporate Two Enable Inputs to Simplify Cascading and/or Data Reception
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Small-Outline (D, NS), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), and Thin Shrink Small-Outline (PW) Packages, Ceramic Flat (W) Packages, Chip Carriers (FK), and DIPs (J)

SN54LV139A . . . J OR W PACKAGE
SN74LV139A . . . D, DB, DGV, NS, OR PW PACKAGE
(TOP VIEW)

1$\overline{G}$	1		16	V_{CC}
1A	2		15	2$\overline{G}$
1B	3		14	2A
1Y0	4		13	2B
1Y1	5		12	2Y0
1Y2	6		11	2Y1
1Y3	7		10	2Y2
GND	8		9	2Y3

SN54LV139A . . . FK PACKAGE
(TOP VIEW)

Pins (top, left to right): 1A, 1$\overline{G}$, NC, V_{CC}, 2$\overline{G}$ (4 3 2 1 20 19)

1B	4		18	2A
1Y0	5		17	2B
NC	6		16	NC
1Y1	7		15	2Y0
1Y2	8		14	2Y1

Pins (bottom, 9 10 11 12 13): 1Y3, GND, NC, 2Y3, 2Y2
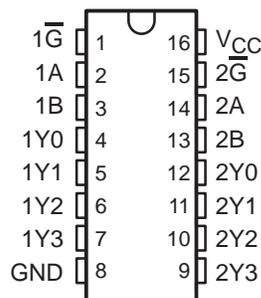
NC – No internal connection

description

The 'LV139A devices are dual 2-line to 4-line decoders/demultiplexers designed for 2-V to 5.5-V V_{CC} operation.

These devices are designed for high-performance memory-decoding or data-routing applications requiring very short propagation delay times. In high-performance memory systems, these decoders can minimize the effects of system decoding. When employed with high-speed memories utilizing a fast enable circuit, the delay time of these decoders and the enable time of the memory are usually less than the typical access time of the memory. This means that the effective system delay introduced by the decoders is negligible.
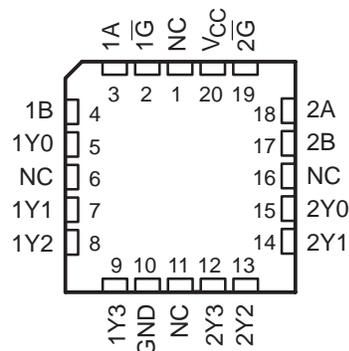
The 'LV139A devices comprise two individual 2-line to 4-line decoders in a single package. The active-low enable ($\overline{G}$) input can be used as a data line in demultiplexing applications. These decoders/demultiplexers feature fully buffered inputs, each of which represents only one normalized load to its driving circuit.

The SN54LV139A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LV139A is characterized for operation from –40°C to 85°C.
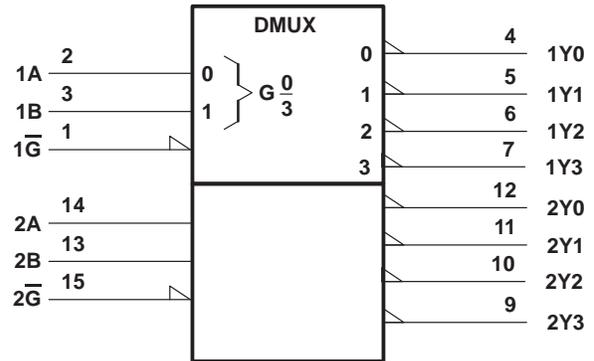
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SN54LV139A, SN74LV139A
DUAL 2-LINE TO 4-LINE DECODERS/DEMULTIPLEXERS

SCLS396B – APRIL 1998 – REVISED MAY 2000

FUNCTION TABLE

INPUTS			OUTPUTS			
$\overline{G}$	SELECT		Y0	Y1	Y2	Y3
	B	A				
H	X	X	H	H	H	H
L	L	L	L	H	H	H
L	L	H	H	L	H	H
L	H	L	H	H	L	H
L	H	H	H	H	H	L

logic symbols (alternatives)†
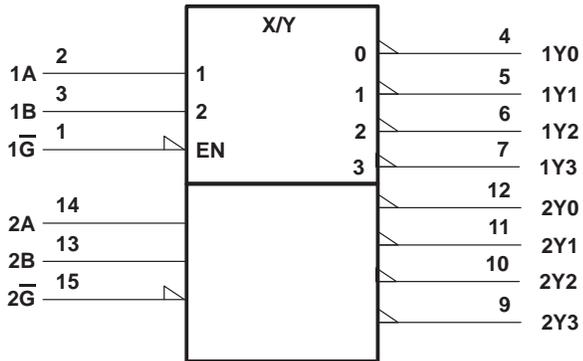
† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, DB, DGV, J, NS, PW, and W packages.

logic diagram (positive logic)

Pin numbers shown are for the D, DB, DGV, J, NS, PW, and W packages.

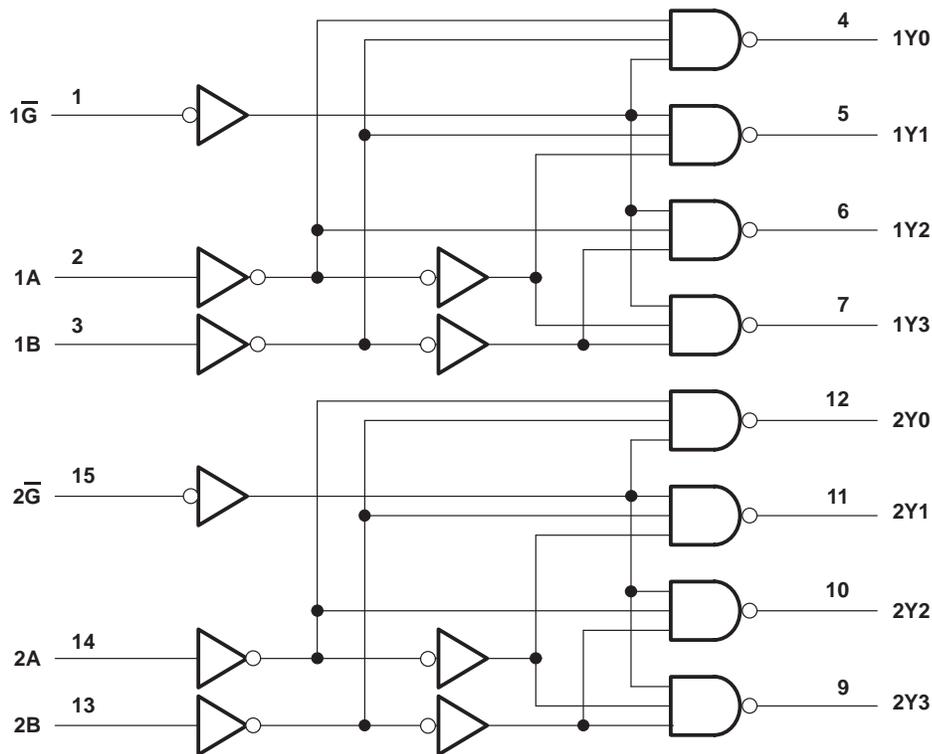## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} .... –0.5 V to 7 V
Input voltage range, V_I (see Note 1) .... –0.5 V to 7 V
Voltage range applied to any output in the high-impedance
  or power-off state, V_O (see Note 1) .... –0.5 V to 7 V
Output voltage range, V_O (see Notes 1 and 2) .... –0.5 V to V_{CC} + 0.5 V
Input clamp current, I_{IK} (V_I < 0) .... –20 mA
Output clamp current, I_{OK} (V_O < 0 or V_O > V_{CC}) .... ±50 mA
Continuous output current, I_O (V_O = 0 to V_{CC}) .... ±25 mA
Continuous current through V_{CC} or GND .... ±50 mA
Package thermal impedance, θ_{JA} (see Note 3): D package .... 73°C/W
                                                         DB package .... 82°C/W
                                                        DGV package .... 120°C/W
                                                        NS package .... 64°C/W
                                                        PW package .... 108°C/W
Storage temperature range, T_{stg} .... –65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and
  functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not
  implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
        2. This value is limited to 5.5 V maximum.
        3. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 4)

			SN54LV139A		SN74LV139A		UNIT
			MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage		2	5.5	2	5.5	V
V_{IH}	High-level input voltage	V_{CC} = 2 V	1.5		1.5		V
		V_{CC} = 2.3 V to 2.7 V	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		
		V_{CC} = 3 V to 3.6 V	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		
		V_{CC} = 4.5 V to 5.5 V	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		
V_{IL}	Low-level input voltage	V_{CC} = 2 V		0.5		0.5	V
		V_{CC} = 2.3 V to 2.7 V		$V_{CC} \times 0.3$		$V_{CC} \times 0.3$	
		V_{CC} = 3 V to 3.6 V		$V_{CC} \times 0.3$		$V_{CC} \times 0.3$	
		V_{CC} = 4.5 V to 5.5 V		$V_{CC} \times 0.3$		$V_{CC} \times 0.3$	
V_I	Input voltage		0	5.5	0	5.5	V
V_O	Output voltage		0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current	V_{CC} = 2 V		−50		−50	µA
		V_{CC} = 2.3 V to 2.7 V		−2		−2	mA
		V_{CC} = 3 V to 3.6 V		−6		−6	
		V_{CC} = 4.5 V to 5.5 V		−12		−12	
I_{OL}	Low-level output current	V_{CC} = 2 V		50		50	µA
		V_{CC} = 2.3 V to 2.7 V		2		2	mA
		V_{CC} = 3 V to 3.6 V		6		6	
		V_{CC} = 4.5 V to 5.5 V		12		12	
$\Delta t/\Delta v$	Input transition rise or fall rate	V_{CC} = 2.3 V to 2.7 V	0	200	0	200	ns/V
		V_{CC} = 3 V to 3.6 V	0	100	0	100	
		V_{CC} = 4.5 V to 5.5 V	0	20	0	20	
T_A	Operating free-air temperature		−55	125	−40	85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V_{CC}	SN54LV139A			SN74LV139A			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V_{OH}	I_{OH} = −50 µA	2 V to 5.5 V	V_{CC}−0.1			V_{CC}−0.1			V
	I_{OH} = −2 mA	2.3 V	2			2			
	I_{OH} = −6 mA	3 V	2.48			2.48			
	I_{OH} = −12 mA	4.5 V	3.8			3.8			
V_{OL}	I_{OL} = 50 µA	2 V to 5.5 V			0.1			0.1	V
	I_{OL} = 2 mA	2.3 V			0.4			0.4	
	I_{OL} = 6 mA	3 V			0.44			0.44	
	I_{OL} = 12 mA	4.5 V			0.55			0.55	
I_I	V_I = V_{CC} or GND	0 V to 5.5 V			±1			±1	µA
I_{CC}	V_I = V_{CC} or GND, I_O = 0	5.5 V			20			20	µA
I_{off}	V_I or V_O = 0 to 5.5 V	0 V			5			5	µA
C_i	V_I = V_{CC} or GND	3.3 V		1.9			1.9		pF

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switching characteristics over recommended operating free-air temperature range, V_{CC} = 2.5 V $\pm$ 0.2 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T_A = 25°C			SN54LV139A		SN74LV139A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{pd}	A or B	Y	C_L = 15 pF		7.7*	17.6*	1*	21*	1	21	ns
	$\overline{G}$	Y			7.4*	15.8*	1*	19*	1	19	
t_{pd}	A or B	Y	C_L = 50 pF		10.2	22.5	1	26.5	1	26.5	ns
	$\overline{G}$	Y			9.9	20.2	1	24	1	24	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T_A = 25°C			SN54LV139A		SN74LV139A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{pd}	A or B	Y	C_L = 15 pF		5.3*	11*	1*	13*	1	13	ns
	$\overline{G}$	Y			5.1*	9.2*	1*	11*	1	11	
t_{pd}	A or B	Y	C_L = 50 pF		7.3	14.5	1	16.5	1	16.5	ns
	$\overline{G}$	Y			7	12.7	1	14.5	1	14.5	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T_A = 25°C			SN54LV139A		SN74LV139A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{pd}	A or B	Y	C_L = 15 pF		3.7*	7.2*	1*	8.5*	1	8.5	ns
	$\overline{G}$	Y			3.5*	6.3*	1*	7.5*	1	7.5	
t_{pd}	A or B	Y	C_L = 50 pF		5.2	9.2	1	10.5	1	10.5	ns
	$\overline{G}$	Y			4.9	8.3	1	9.5	1	9.5	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

operating characteristics, T_A = 25°C

PARAMETER		TEST CONDITIONS	V_{CC}	TYP	UNIT
C_{pd}	Power dissipation capacitance	C_L = 50 pF, f = 10 MHz	3.3 V	17.3	pF
			5 V	18.2	

TEXAS
INSTRUMENTS

PARAMETER MEASUREMENT INFORMATION

LOAD CIRCUIT FOR TOTEM-POLE OUTPUTS

LOAD CIRCUIT FOR 3-STATE AND OPEN-DRAIN OUTPUTS

TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	V_{CC}
t_{PHZ}/t_{PZH}	GND
Open Drain	V_{CC}

**VOLTAGE WAVEFORMS
PULSE DURATION**

**VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES**

**VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS**

**VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING**

NOTES: A. C_L includes probe and jig capacitance.
   B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
      Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
   C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O = 50 Ω, t_r ≤ 3 ns, t_f ≤ 3 ns.
   D. The outputs are measured one at a time with one input transition per measurement.
   E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
   F. t_{PZL} and t_{PZH} are the same as t_{en}.
   G. t_{PHL} and t_{PLH} are the same as t_{pd}.

Figure 1. Load Circuit and Voltage Waveforms

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